

**SD2918**

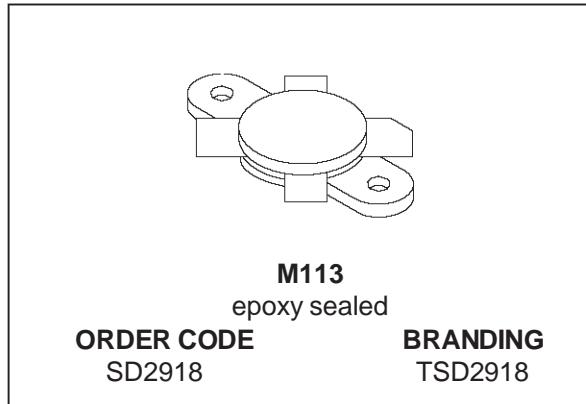
## RF POWER TRANSISTORS HF/VHF/UHF N-CHANNEL MOSFETs

ADVANCE DATA

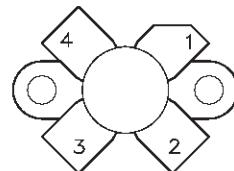
- GOLD METALLIZATION
- EXCELLENT THERMAL STABILITY
- COMMON SOURCE CONFIGURATION
- $P_{out} = 30 \text{ W MIN. WITH } 18 \text{ dB GAIN @ } 30 \text{ MHz}$

### DESCRIPTION

The SD2918 is a gold metallized N-Channel MOS field-effect RF power transistor. It is intended for use in 50 V DC large signal applications up to 200 MHz



### PIN CONNECTION



PC12230

- |           |           |
|-----------|-----------|
| 1. Drain  | 3.Gate    |
| 2. Source | 4. Source |

### ABSOLUTE MAXIMUM RATINGS ( $T_{case} = 25^\circ\text{C}$ )

| Symbol        | Parameter   | Value      | Unit             |
|---------------|---|------------|------------------|
| $V_{(BR)DSS}$ | Drain Source Voltage                                | 125        | V                |
| $V_{DGR}$     | Drain-Gate Voltage ( $R_{GS} = 1 \text{ M}\Omega$ ) | 125        | V                |
| $V_{GS}$      | Gate-Source Voltage                                 | $\pm 20$   | V                |
| $I_D$         | Drain Current                                       | 6          | A                |
| $P_{DISS}$    | Power Dissipation                                   | 175        | W                |
| $T_j$         | Max. Operating Junction Temperature                 | 200        | $^\circ\text{C}$ |
| $T_{STG}$     | Storage Temperature                                 | -65 to 150 | $^\circ\text{C}$ |

### THERMAL DATA

|               |                                    |      |                    |
|---------------|------------------------------------|------|--------------------|
| $R_{th(j-c)}$ | Junction-Case Thermal Resistance   | 1.0  | $^\circ\text{C/W}$ |
| $R_{th(c-s)}$ | Case-Heatsink Thermal Resistance * | 0.30 | $^\circ\text{C/W}$ |

\* Determined using a flat aluminum or copper heatsink with thermal compound applied (Dow Corning 340 or equivalent).

# SD2918

## ELECTRICAL SPECIFICATION ( $T_{case} = 25^{\circ}\text{C}$ )

### STATIC

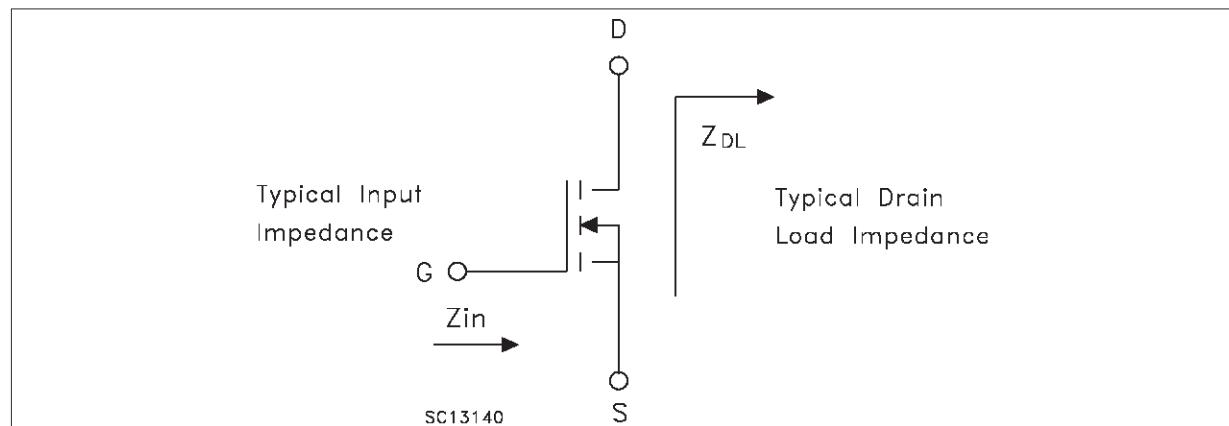
| Symbol        | Parameter             |                         | Min.               | Typ. | Max. | Unit          |
|---------------|-----------------------|-------------------------|--------------------|------|------|---------------|
| $V_{(BR)DSS}$ | $V_{GS} = 0\text{V}$  | $I_{DS} = 10\text{ mA}$ | 125                |      |      | V             |
| $I_{DSS}$     | $V_{GS} = 0\text{V}$  | $V_{DS} = 50\text{ V}$  |                    |      | 1.0  | mA            |
| $I_{GSS}$     | $V_{GS} = 20\text{V}$ | $V_{DS} = 0\text{ V}$   |                    |      | 1    | $\mu\text{A}$ |
| $V_{GS(Q)}$   | $V_{DS} = 10\text{V}$ | $I_D = 10\text{ mA}$    | 1.0                |      | 5.0  | V             |
| $V_{DS(ON)}$  | $V_{GS} = 10\text{V}$ | $I_D = 2.5\text{ A}$    |                    |      | 5.0  | V             |
| $g_{FS}$      | $V_{DS} = 10\text{V}$ | $I_D = 2.5\text{ A}$    | 0.8                |      |      | mho           |
| $C_{ISS}$     | $V_{GS} = 0\text{V}$  | $V_{DS} = 50\text{ V}$  | $f = 1\text{ MHz}$ | 58   |      | pF            |
| $C_{OSS}$     | $V_{GS} = 0\text{V}$  | $V_{DS} = 50\text{ V}$  | $f = 1\text{ MHz}$ | 35.5 |      | pF            |
| $C_{RSS}$     | $V_{GS} = 0\text{V}$  | $V_{DS} = 50\text{ V}$  | $f = 1\text{ MHz}$ | 7.5  |      | pF            |

REF. 1022497C

### DYNAMIC

| Symbol        | Parameter          |                       |                           |                          | Min. | Typ. | Max. | Unit |
|---------------|--------------------|-----------------------|---------------------------|--------------------------|------|------|------|------|
| $P_{OUT}$     | $f = 30\text{MHz}$ | $V_{DD} = 50\text{V}$ | $P_{in} = 0.475\text{ W}$ | $I_{DQ} = 100\text{ mA}$ | 30   |      |      | W    |
| $G_{PS}$      | $f = 30\text{MHz}$ | $V_{DD} = 50\text{V}$ | $P_{out} = 30\text{ W}$   | $I_{DQ} = 100\text{ mA}$ | 18   | 22   |      | dB   |
| $\eta_D$      | $f = 30\text{MHz}$ | $V_{DD} = 50\text{V}$ | $P_{out} = 30\text{ W}$   | $I_{DQ} = 100\text{ mA}$ | 50   | 55   |      | %    |
| Load Mismatch | $f = 30\text{MHz}$ | $V_{DD} = 50\text{V}$ | $P_{out} = 30\text{ W}$   | $I_{DQ} = 100\text{ mA}$ | 30:1 |      |      | VSWR |
| All Angles    |                    |                       |                           |                          |      |      |      |      |

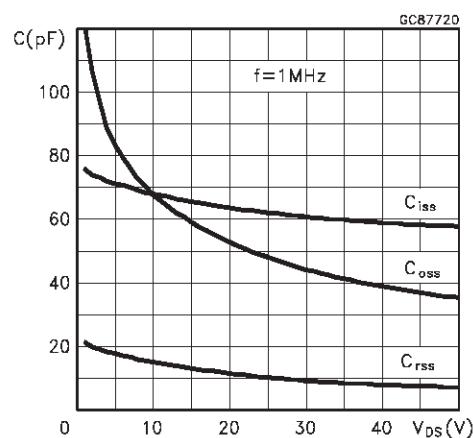
### IMPEDANCE DATA



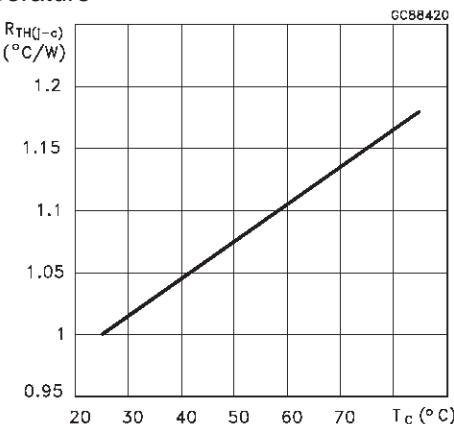
| FREQ.  | $Z_{in} (\Omega)$ | $Z_{DL} (\Omega)$ |
|--------|-------------------|-------------------|
| 30 MHz | $24.4 - j 13.4$   | $28.8 + j 7.2$    |

## TYPICAL PERFORMANCE

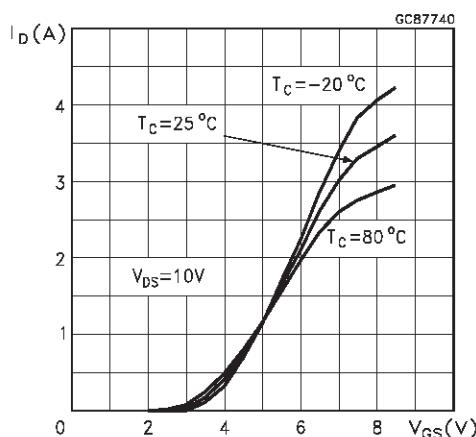
Capacitance vs Drain-Source Voltage



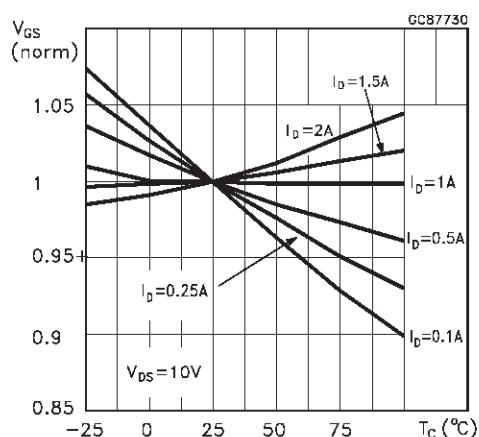
Maximum Thermal Resistance vs Case Temperature



Drain Current vs Gate Voltage

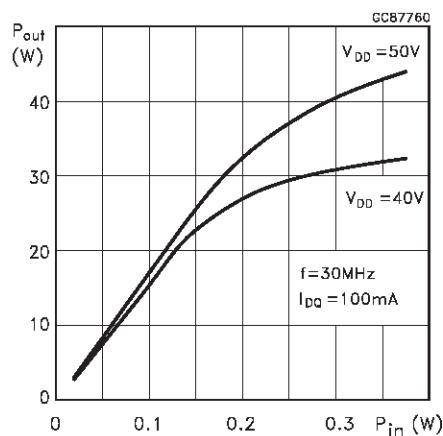


Gate-Source Voltages vs Case Temperature

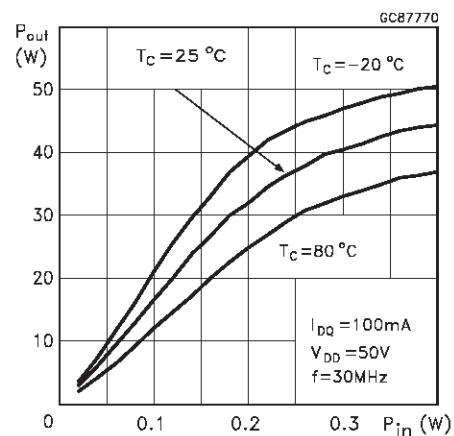


**TYPICAL PERFORMANCE**

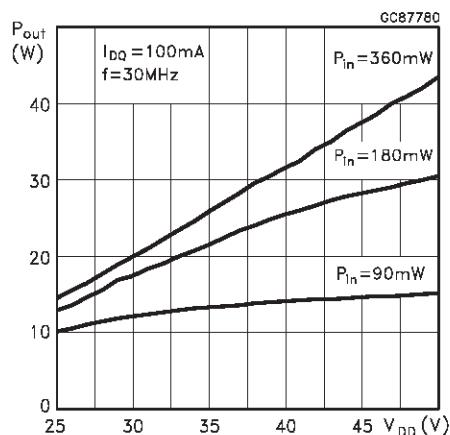
Output Power vs Input Power



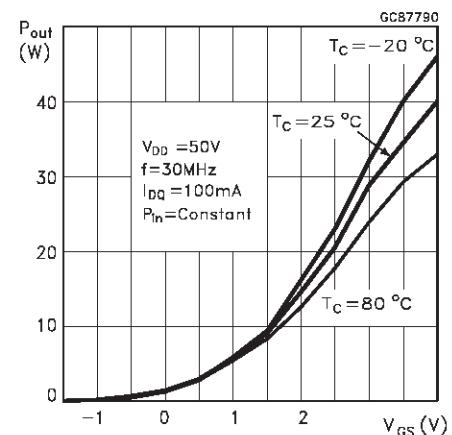
Output Power vs Input Power



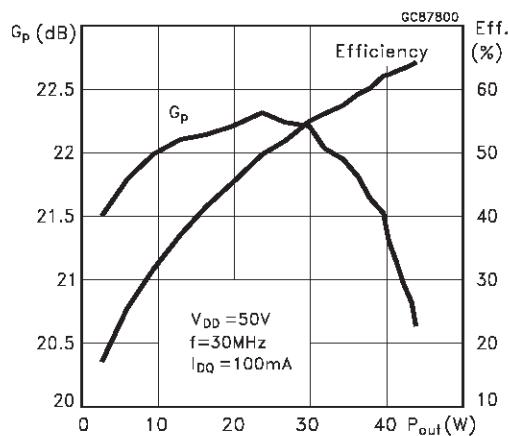
Output Power vs Voltage Supply



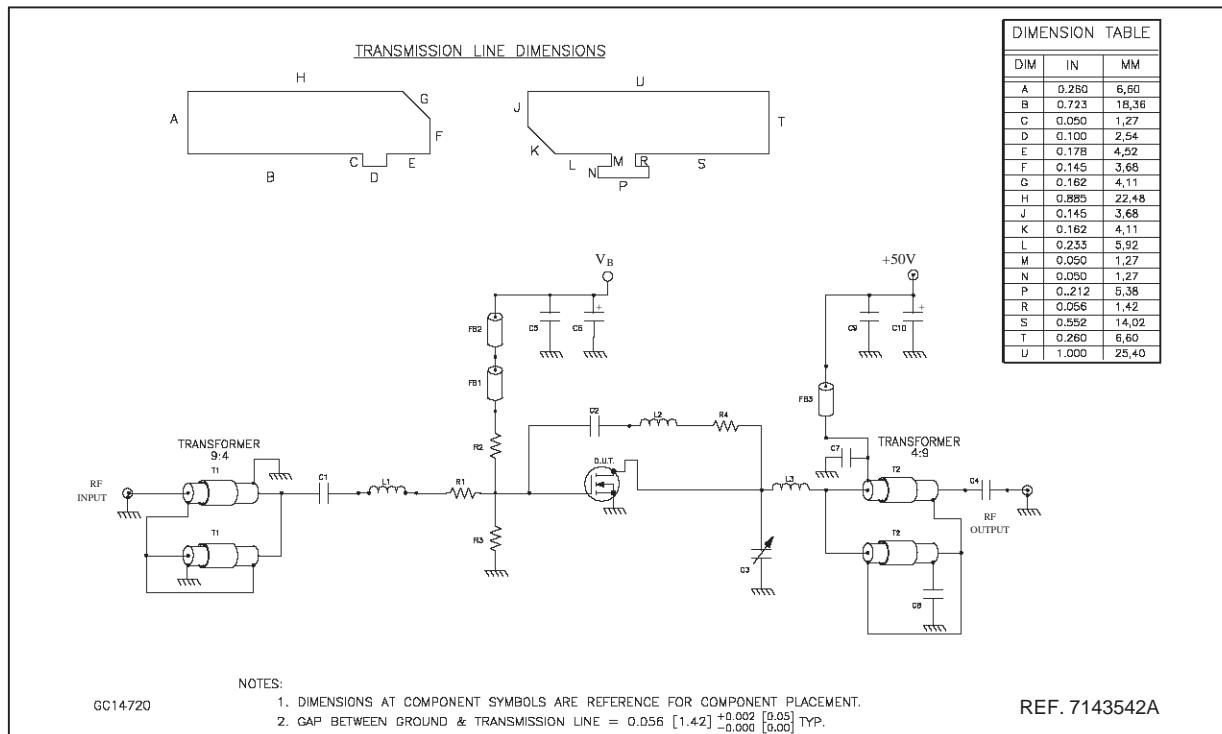
Output Power vs Gate Voltage



Power Gain & Efficiency vs Output Power



## 30 MHz Test Circuit Schematic



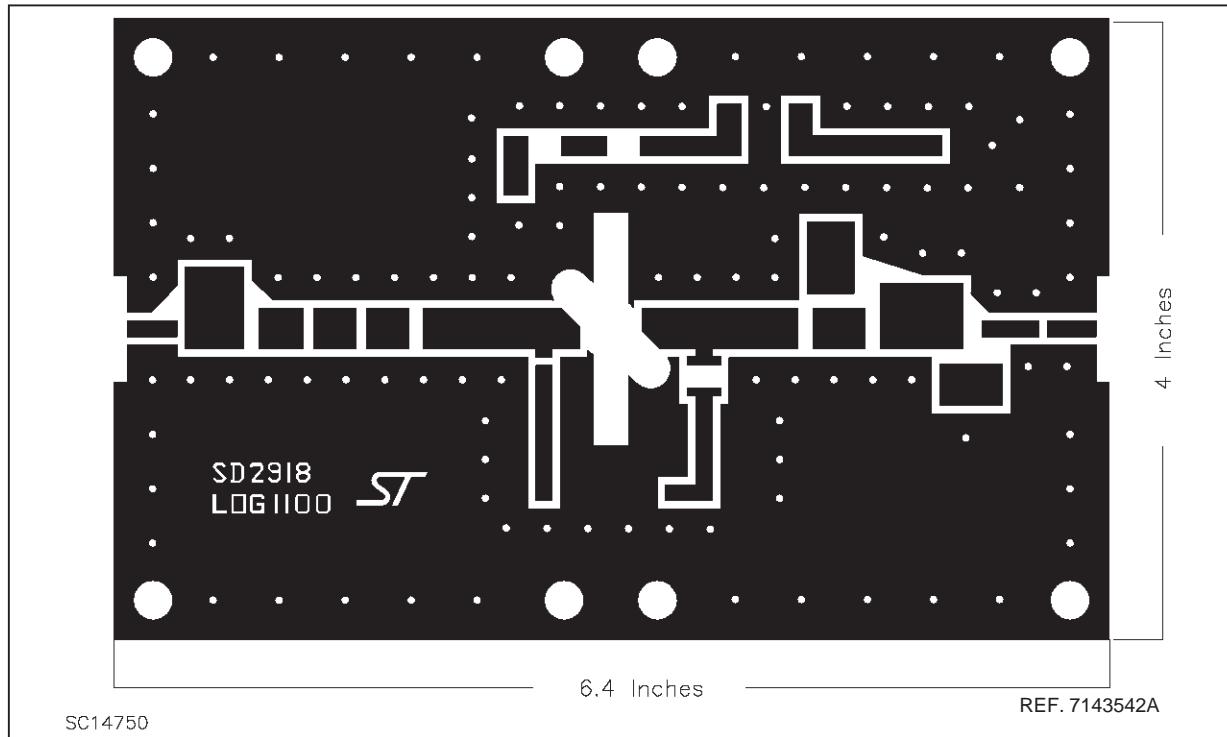
## 30 MHz Test Circuit Component Part List

| COMPONENT | PART NO            | VENDOR          | DESCRIPTION   |
|-----------|--------------------|-----------------|---|
| R4        | CR2512-1W-101JB    | VENKEL          | 100 OHM, 1W SURFACE MOUNT CHIP RESISTOR   |
| R3        | 29SJ901            | XICON           | 160 OHM, 1W CARBON FILM AXIAL-LEAD RESISTOR   |
| R2        | 29SJ901            | XICON           | 160 OHM, 1W CARBON FILM AXIAL-LEAD RESISTOR   |
| R1        | CR2512-1W-3R9JT    | VENKEL          | 3.9 OHM, 1W SURFACE MOUNT CHIP RESISTOR   |
| FB3       | 2843000102         | FAIR-RITE CORP. | MULTI-APERATURE CORE  |
| FB2       | 2743021447         | FAIR-RITE CORP. | SHIELD BEAD SURFACE MOUNT EMI   |
| FB1       | 2743021447         | FAIR-RITE CORP. | SHIELD BEAD SURFACE MOUNT EMI   |
| L3        | 8073               | BELDEN          | INDUCTOR, 3 TURNS AIR WOUND #14AWG, ID=0.375[9.53], POLY COATED MAGNET WIRE   |
| L2        | 1557               | ALPHA           | INDUCTOR, 7 TURNS AROUND SHIELD BEAD (PT# FAIR-RITE 26438011D2) #16AWG HOOK UP WIRE.                                  |
| L1        | 8073               | BELDEN          | INDUCTOR, 4 TURNS AIR WOUND #14AWG, ID=0.375[9.53], POLY COATED MAGNET WIRE   |
| C10       | SKA100M160         | MALLORY         | 10μF/160V AXIAL-LEAD ALUMINIUM ELECTROLYTIC CAPACITOR   |
| C9        | C1B12X7R501-103KNE | VENKEL          | 0.01μF/500V SURFACE MOUNT CERAMIC CHIP CAPACITOR  |
| C8        | C1B12X7R501-103KNE | VENKEL          | 0.01μF/500V SURFACE MOUNT CERAMIC CHIP CAPACITOR  |
| C7        | C1B12X7R501-103KNE | VENKEL          | 0.01μF/500V SURFACE MOUNT CERAMIC CHIP CAPACITOR  |
| C6        | RV5-50V100M-R      | ELNA            | 10μF/50V VERTICAL SURFACE MOUNT CHIP ALUMINUM ELECTROLYTIC CAPACITOR  |
| C5        | C1B12X7R501-103KNE | VENKEL          | 0.01μF/500V SURFACE MOUNT CERAMIC CHIP CAPACITOR  |
| C4        | ATC200B103KW50X    | ATC             | 10000pF ATC 200B SURFACE MOUNT CERAMIC CHIP CAPACITOR   |
| C3        | 463                | ARCO            | 20-180pF TYPE ST46 STANDARD 3 TURNS VARIABLE CAPACITOR  |
| C2        | ATC200B103KW50X    | ATC             | 10000pF ATC 200B SURFACE MOUNT CERAMIC CHIP CAPACITOR   |
| C1        | ATC200B103KW50X    | ATC             | 10000pF ATC 200B SURFACE MOUNT CERAMIC CHIP CAPACITOR   |
| T2        |                    |                 | TRANSFORMER, 4:1 75.0 OHM, O.D. 0.090 1" LG. COAXIAL CABLE 5 TURNS AROUND SHIELD BEAD (PT#2643801002 FAIR-RITE CORP.) |
| T1        |                    |                 | TRANSFORMER, 9:4 75.0 OHM, O.D. 0.090 1" LG. COAXIAL CABLE 5 TURNS AROUND SHIELD BEAD (PT#2643801002 FAIR-RITE CORP.) |
| PCB       | G0300M1026         | ROGERS CORP     | WOVEN FIBERGLASS REINFORCED PTFE 0.030" THK, $\epsilon_r = 2.55$ , 2 Oz ED Cu   |
|           |                    |                 | BOTH SIDES  |

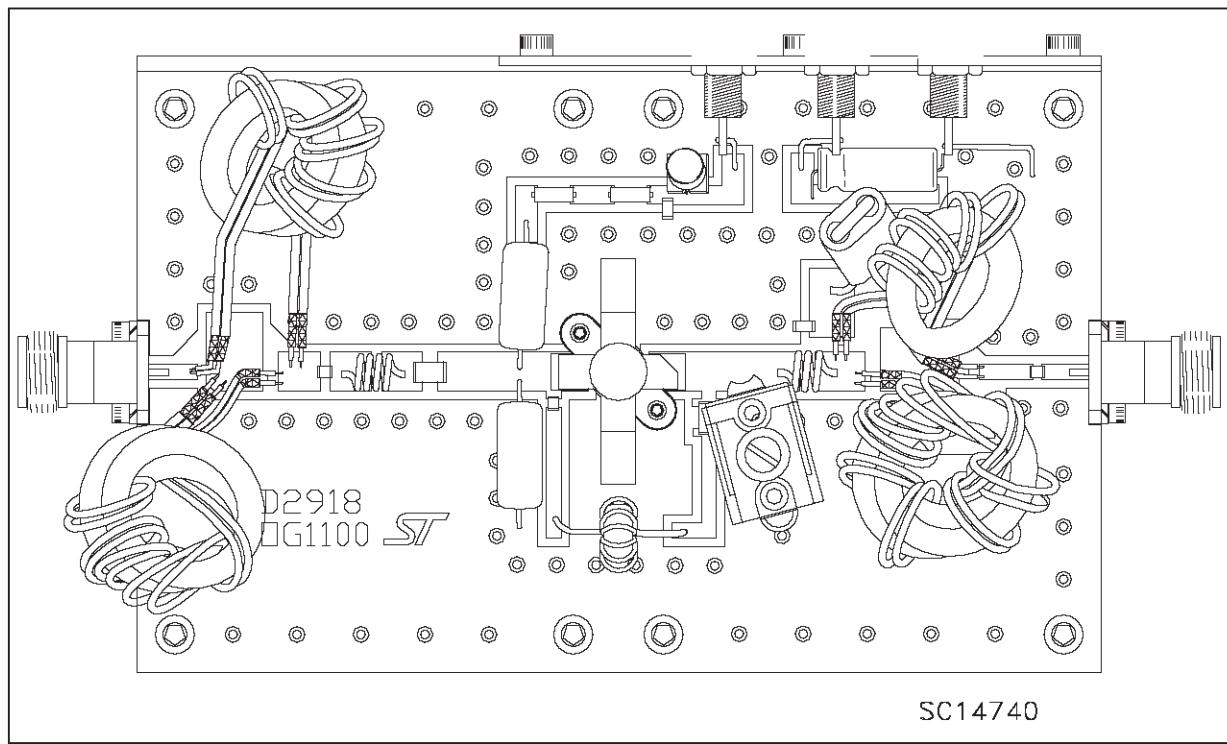
SC14730

## SD2918

30 MHz Test Circuit Photomaster

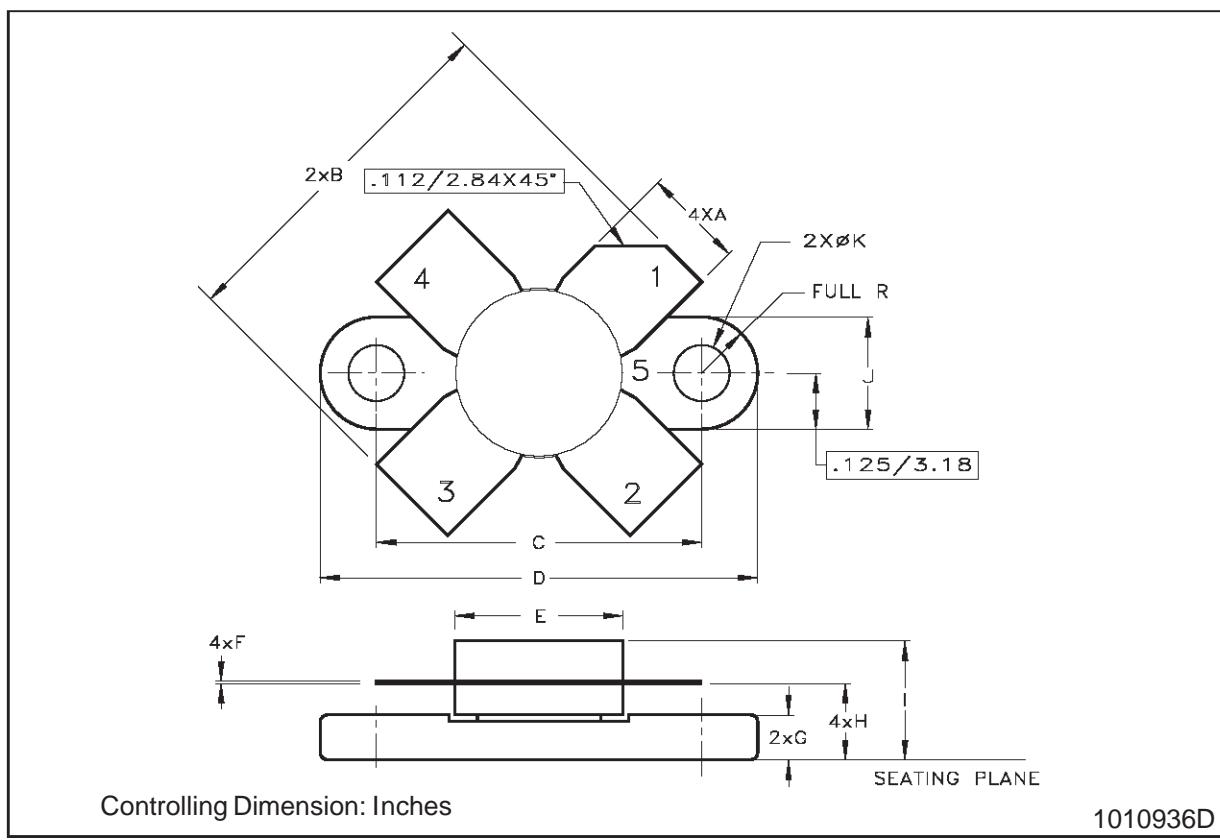


30 MHz Production Test Fixture



**M113 (.380 DIA 4/L N/HERM W/FLG) MECHANICAL DATA**

| DIM. | mm    |      |       | inch  |      |       |
|------|-------|------|-------|-------|------|-------|
|      | MIN.  | TYP. | MAX.  | MIN.  | TYP. | MAX.  |
| A    | 5.59  |      | 5.84  | 0.220 |      | 0.230 |
| B    | 19.81 |      | 20.83 | 0.780 |      | 0.820 |
| C    | 18.29 |      | 18.54 | 0.720 |      | 0.730 |
| D    | 24.64 |      | 24.89 | 0.970 |      | 0.980 |
| E    | 9.40  |      | 9.78  | 0.370 |      | 0.385 |
| F    | 0.10  |      | 0.15  | 0.004 |      | 0.006 |
| G    | 2.16  |      | 2.67  | 0.085 |      | 0.105 |
| H    | 4.06  |      | 4.57  | 0.160 |      | 0.180 |
| I    |       |      | 7.14  |       |      | 0.281 |
| J    | 6.22  |      | 6.48  | 0.245 |      | 0.255 |
| K    | 3.05  |      | 3.30  | 0.120 |      | 0.130 |



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